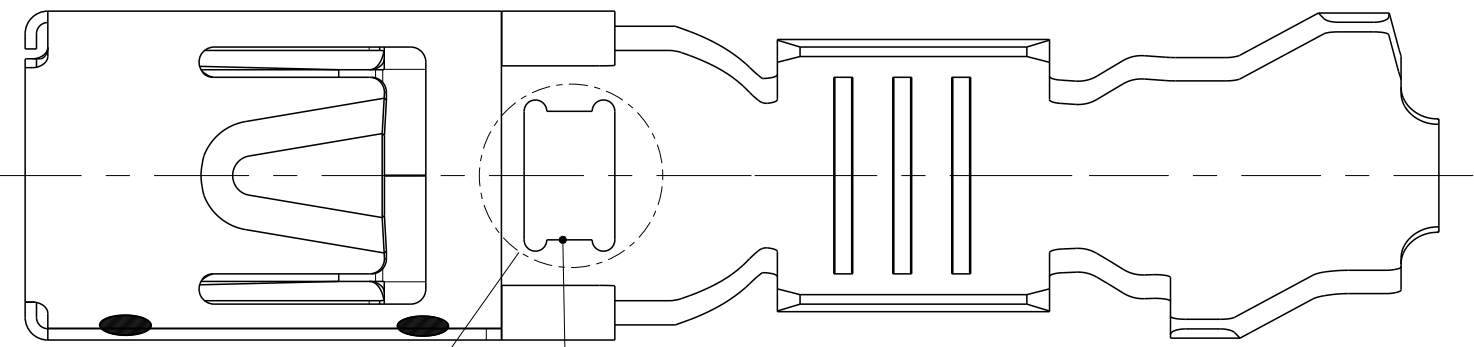
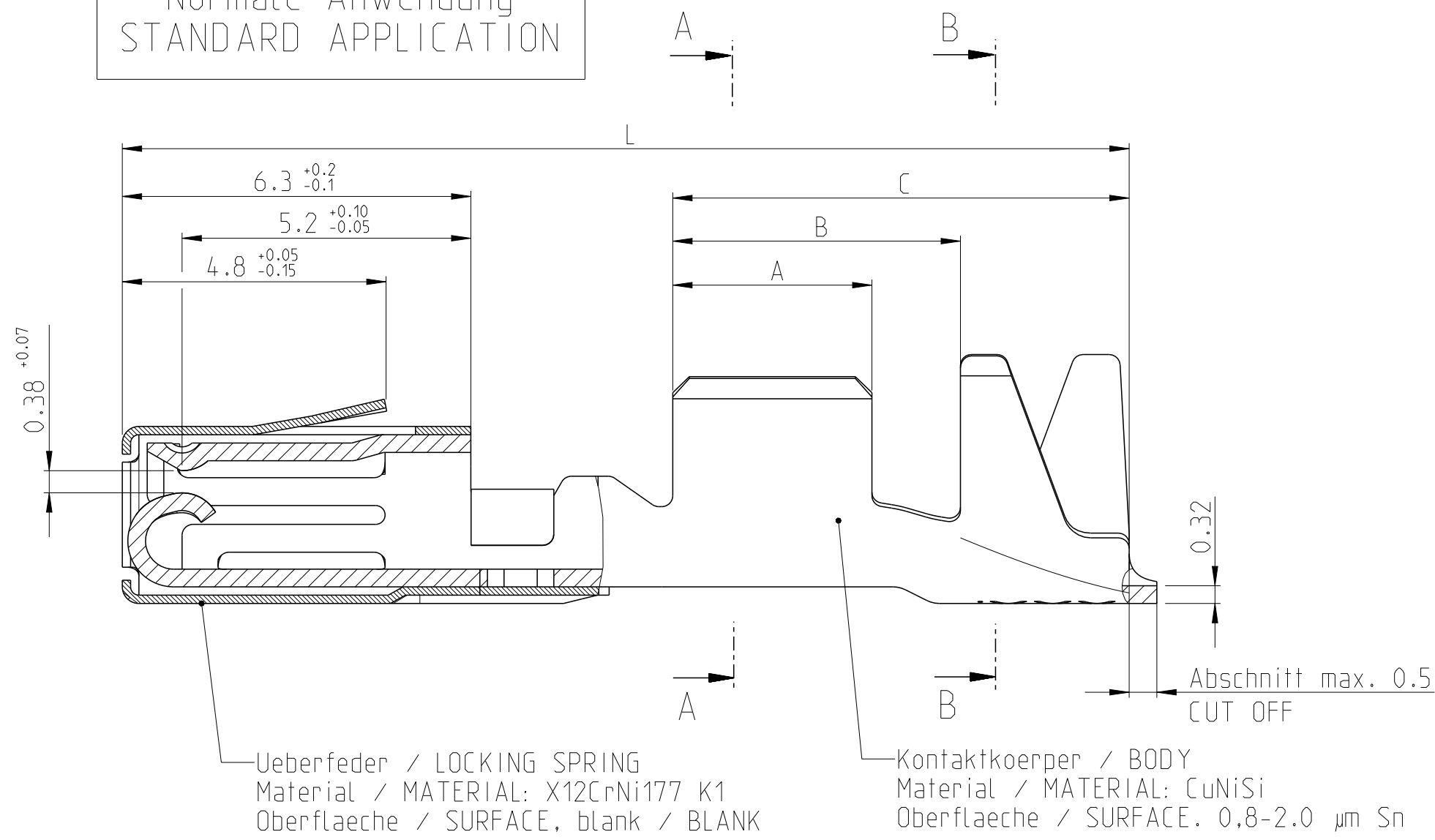


Normale Anwendung

STANDARD APPLICATION



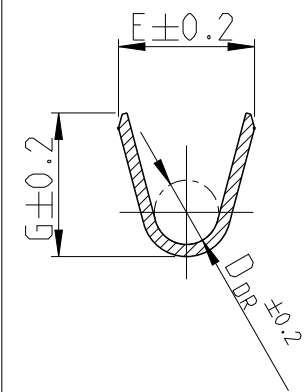
Fenster nicht fuer DGB 2.5-4.0 mm²
NO WINDOW FOR WIRE SIZE RANGE 2.5-4.0 mm²

optional
OPTIONAL

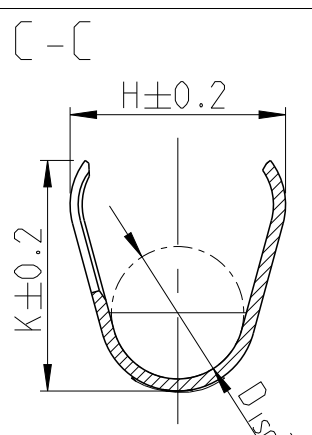
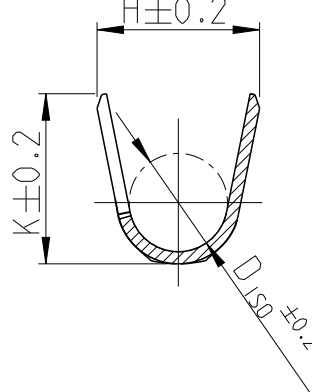
Ueberfeder / LOCKING SPRING
Material / MATERIAL: X12CrNi177 K1
Oberflaeche / SURFACE: blank / BLANK

Kontaktkoerper / BODY
Material / MATERIAL: CuNiSi
Oberflaeche / SURFACE: 0,8-2.0 µm Sn

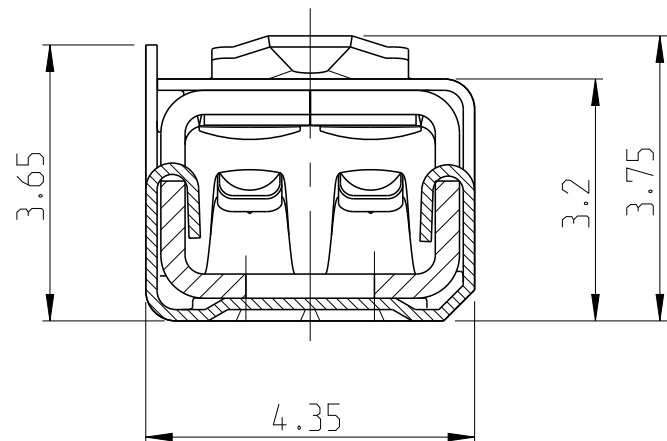
A-A



B-B



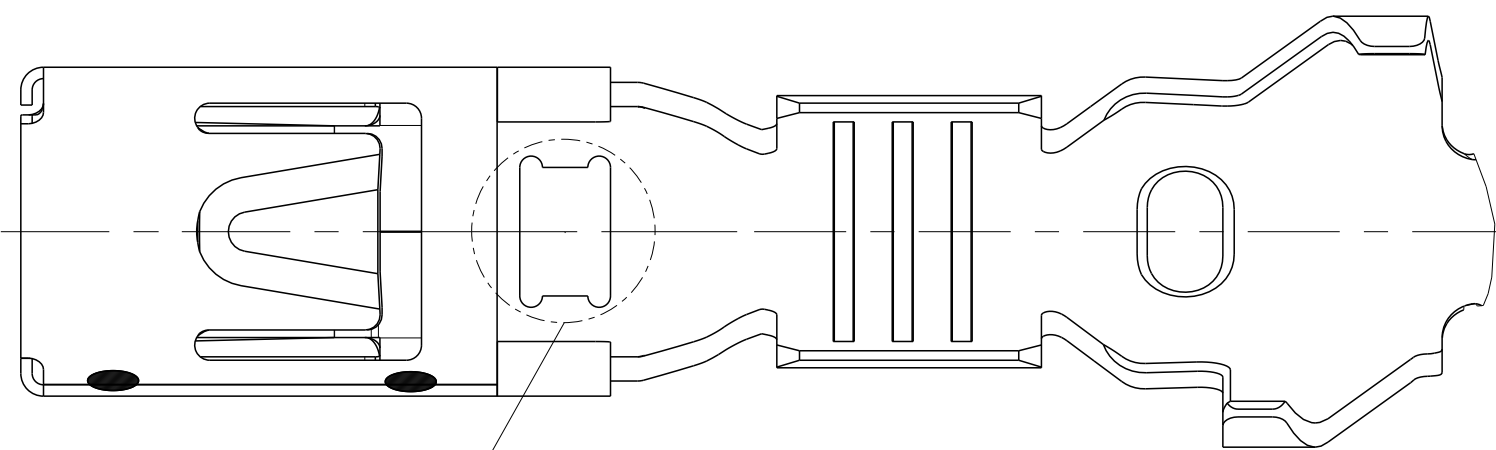
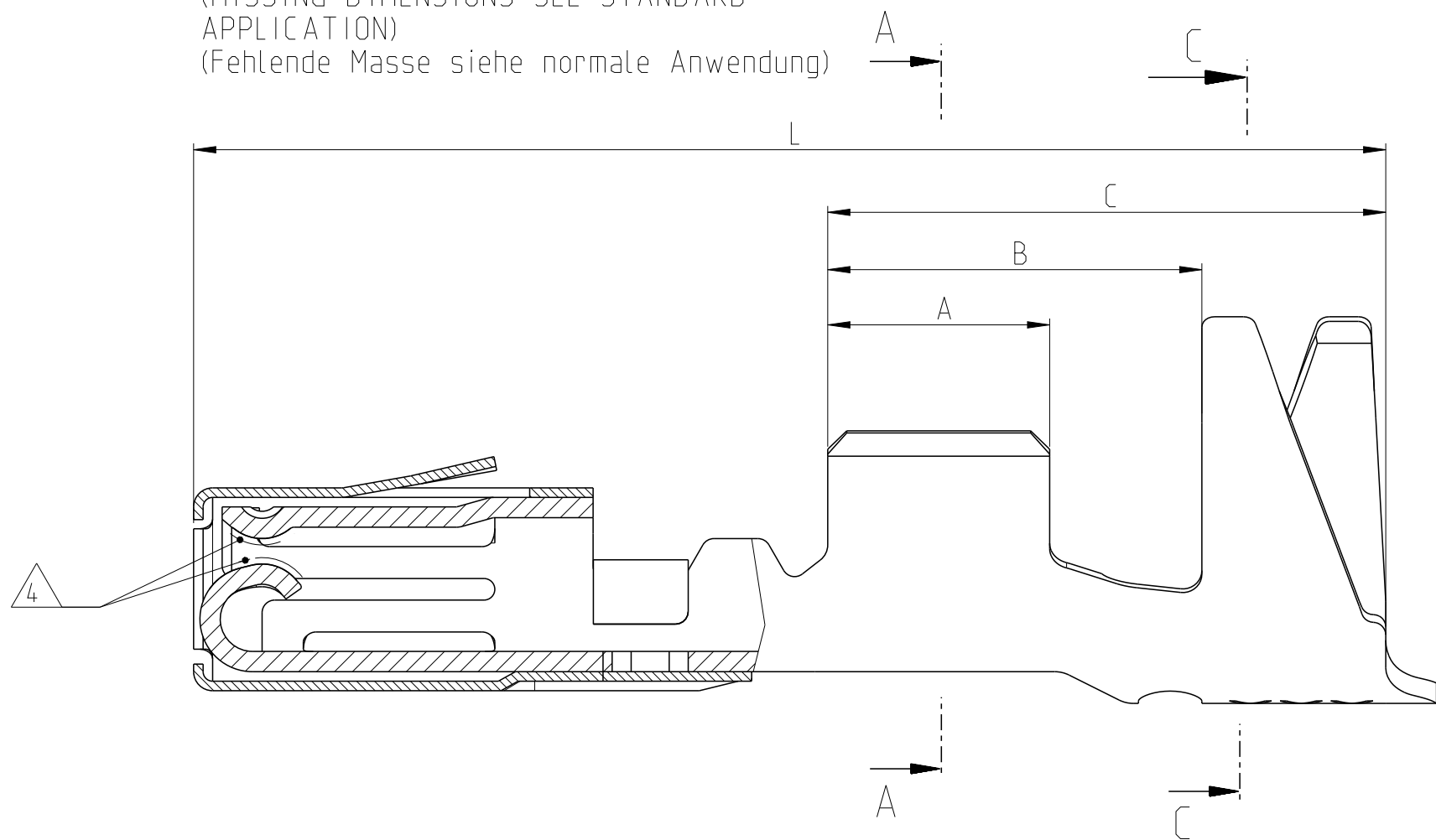
Ansicht ohne Crimp
VIEW WITHOUT CRIMP



Einzelabdichtungssystem

SINGLE WIRE SEAL SYSTEM

(MISSING DIMENSIONS SEE STANDARD APPLICATION)
(Fehlende Masse siehe normale Anwendung)



optional
OPTIONAL

NOTES
Bemerkungen

- SUITABLE FOR PIN CONTACT SEE DRAWING:
Passend zu Stiftkontakt:
TE: 1355933
 - FOR FLR-CONDUCTOR ACCORDING TO DIN 72551. PART 6 ONLY
Nur fuer FLR-Leitungen nach DIN 72551, Teil 6
 - DETAILS OF DESIGN ARE LEFT TO MANUFACTURER
Einzelheiten der Ausfuehrung bleiben dem Hersteller ueberlassen
- △4 MIN. 0.8 µm Au OVER MIN. 1.2 µm Ni
Min. 0.8 µm Au ueber min. 1.2 µm Ni
- △5 2-4 µm ELECTROPLATED SILVER
2-4 µm galvanisch Silber
- △6 MIN. 0.8 µm PdNi OVER MIN. 1.2 µm Ni
Min. 0.8 µm PdNi ueber min. 1.2 µm Ni
- △7 FOR INSPECTION PURPOSES ONLY
Nur fuer Pruefzwecke

1:1

1:1

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN S.Garcia 22MAY2000	TE Connectivity	
DIMENSIONS:		CHK R.Jettler 22MAY2000		
mm		APVD -	NAME	
		TOLERANCES UNLESS OTHERWISE SPECIFIED:	PRODUCT SPEC	
		MATERIAL	APPLICATION SPEC	
		FINISH	WEIGHT	
		WEIGHT	Customer Drawing	